

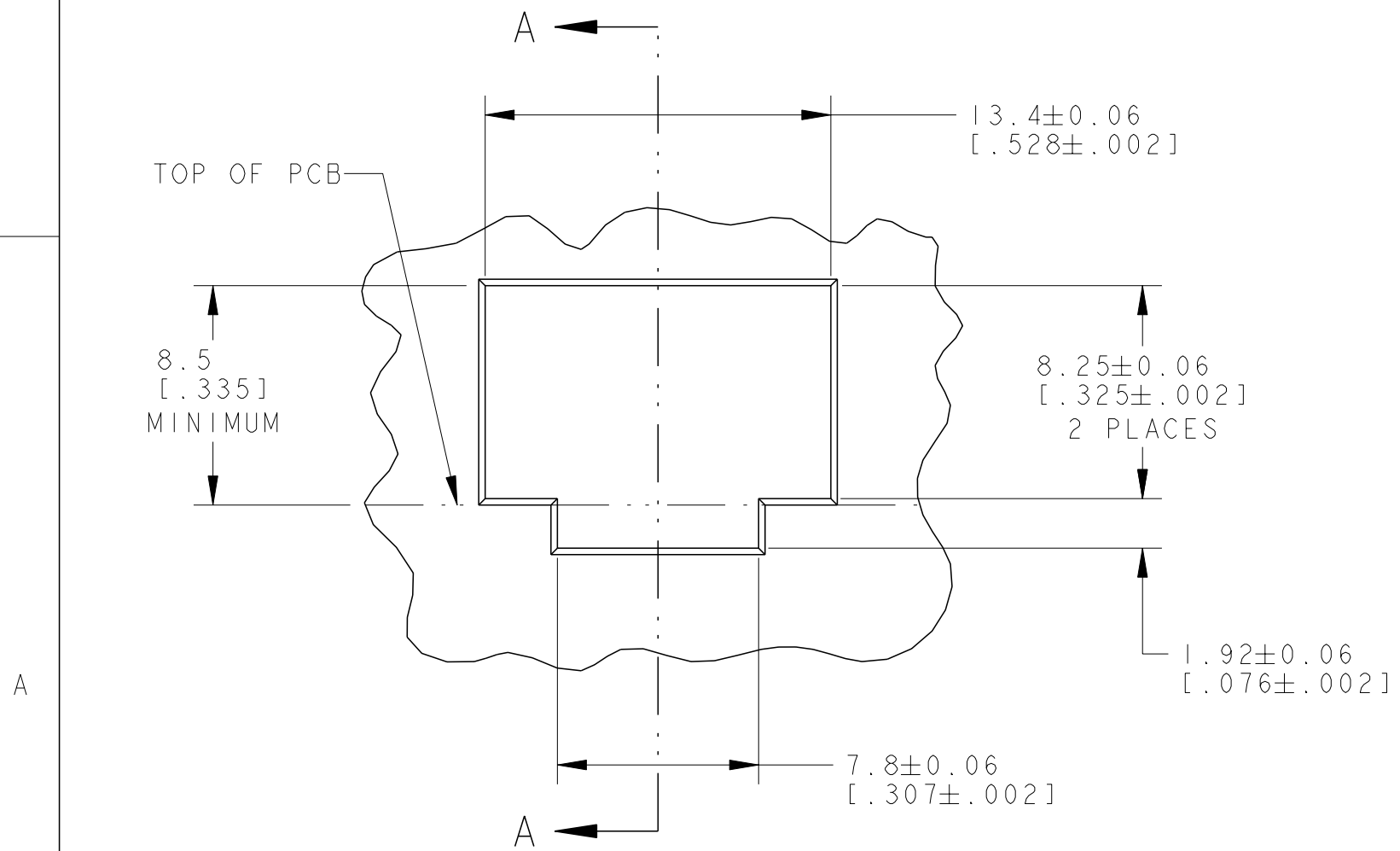
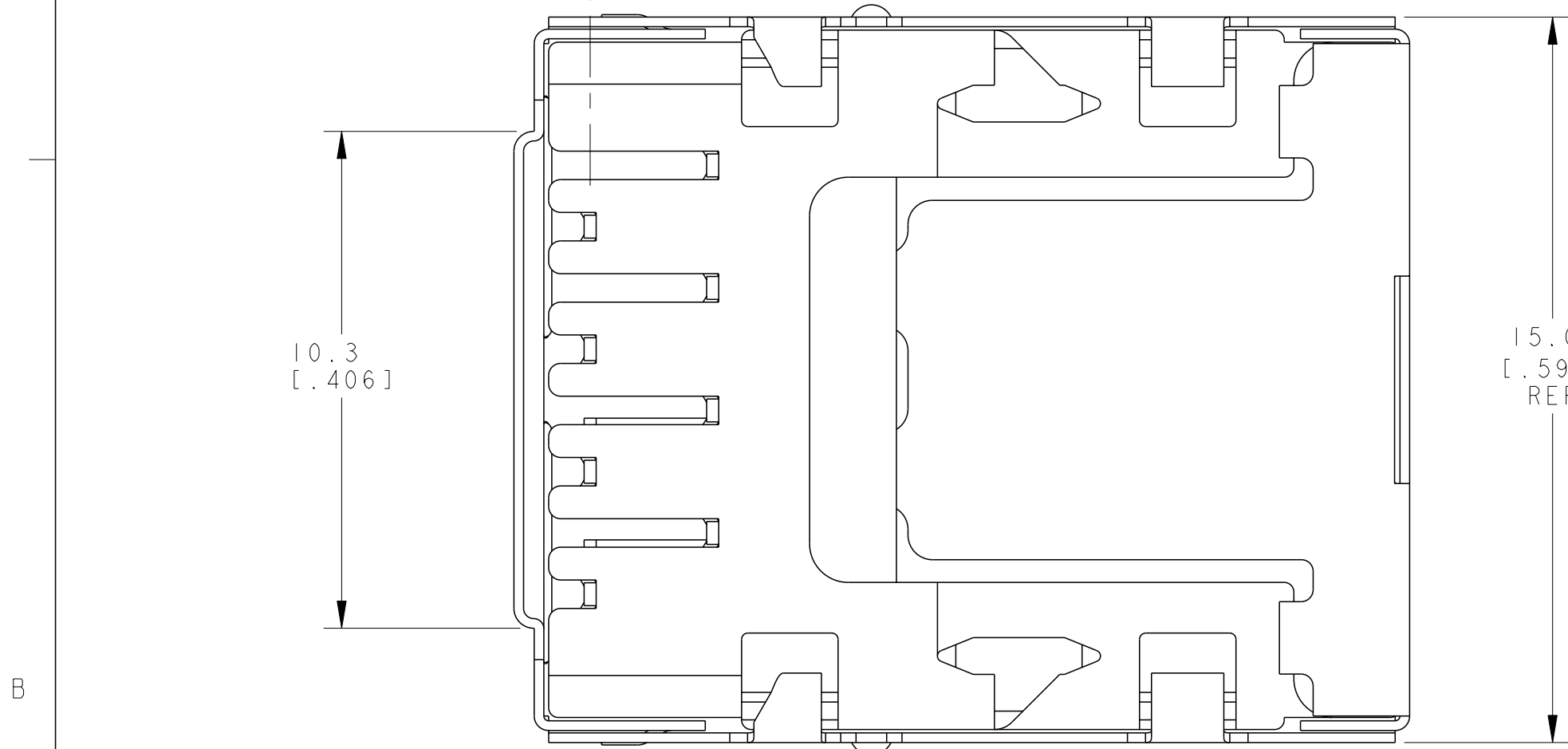
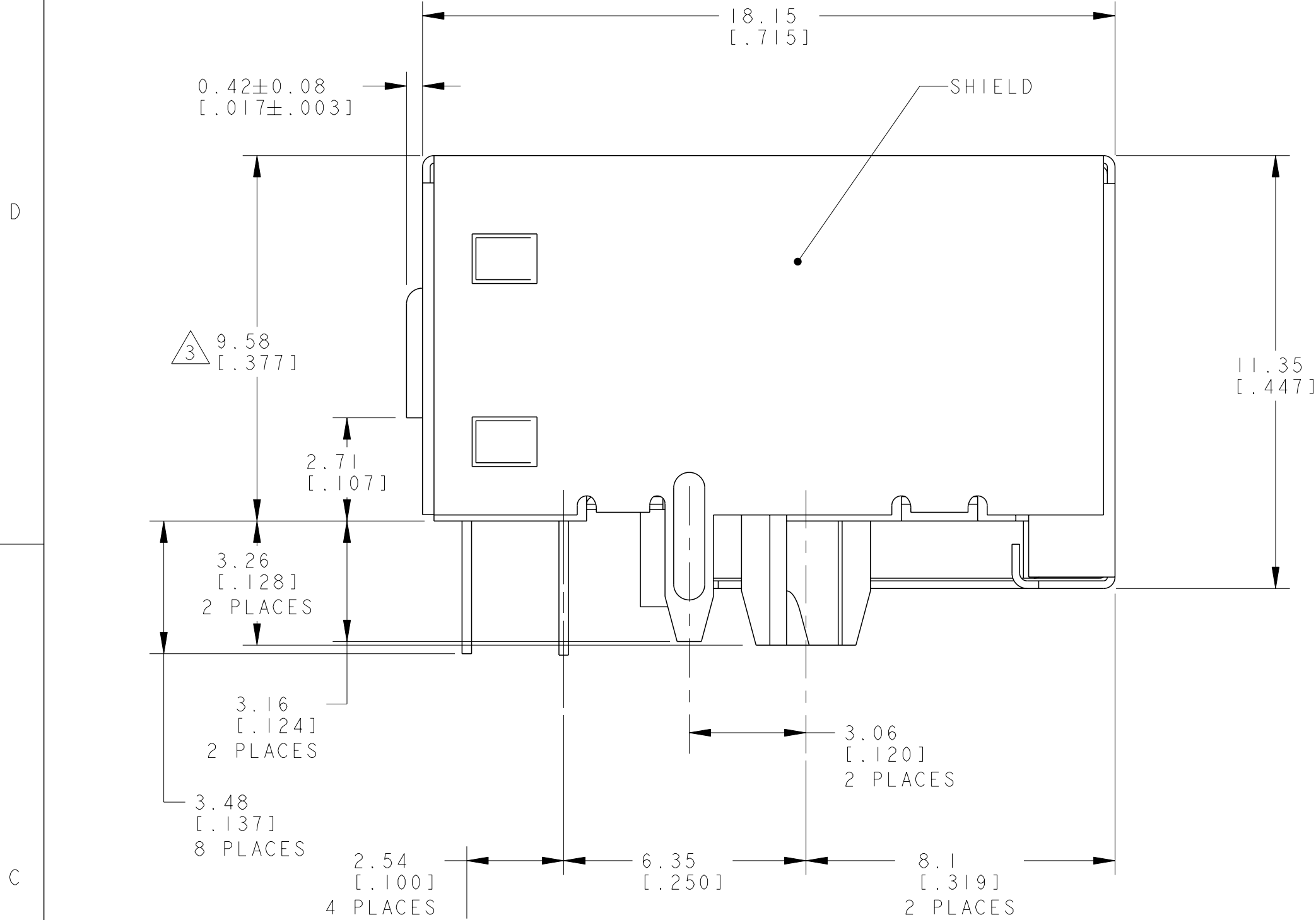
LOC		DIST		REVISIONS						
AA		22		P	LYR	DESCRIPTION	DATE	DWN	APVD	
					N1	REVISED PER ECO-11-005027	12MAY2011	RK	HMR	
					P	REVISED PER ECO-14-015233	27APR2015	LL	SH	
					R	ECO-16-011601	05AUG2016	LL	SH	

D

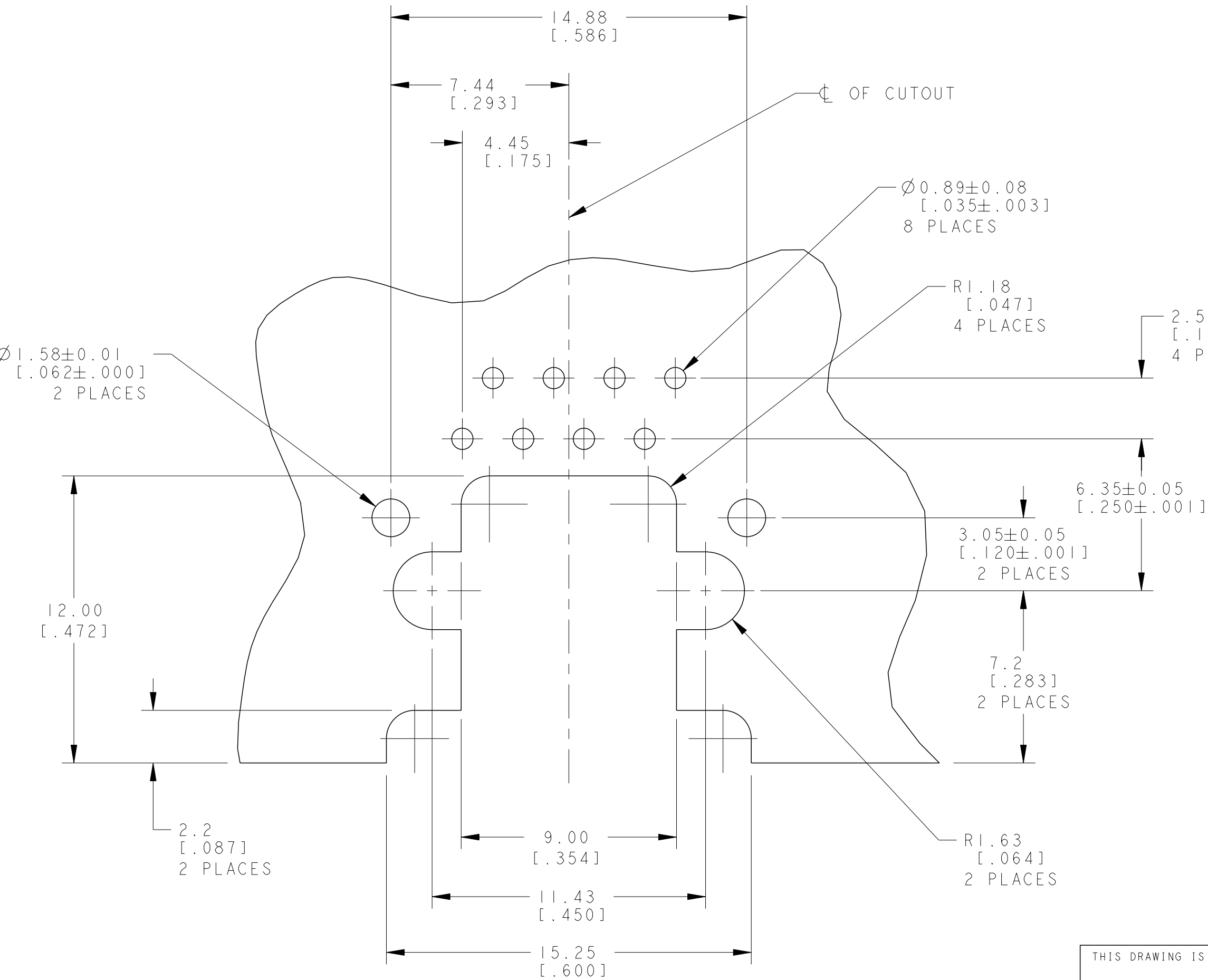
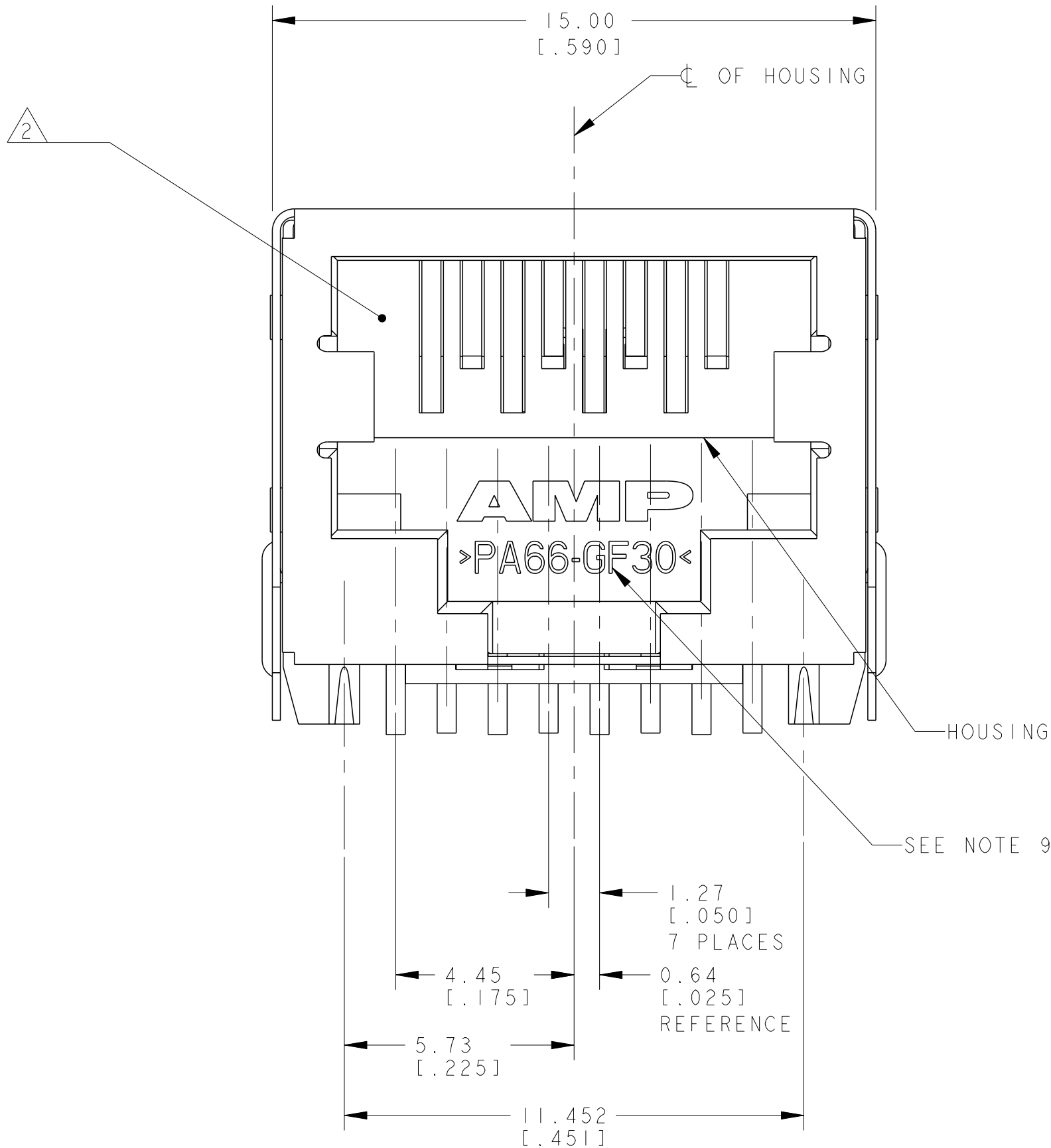
C

B

A

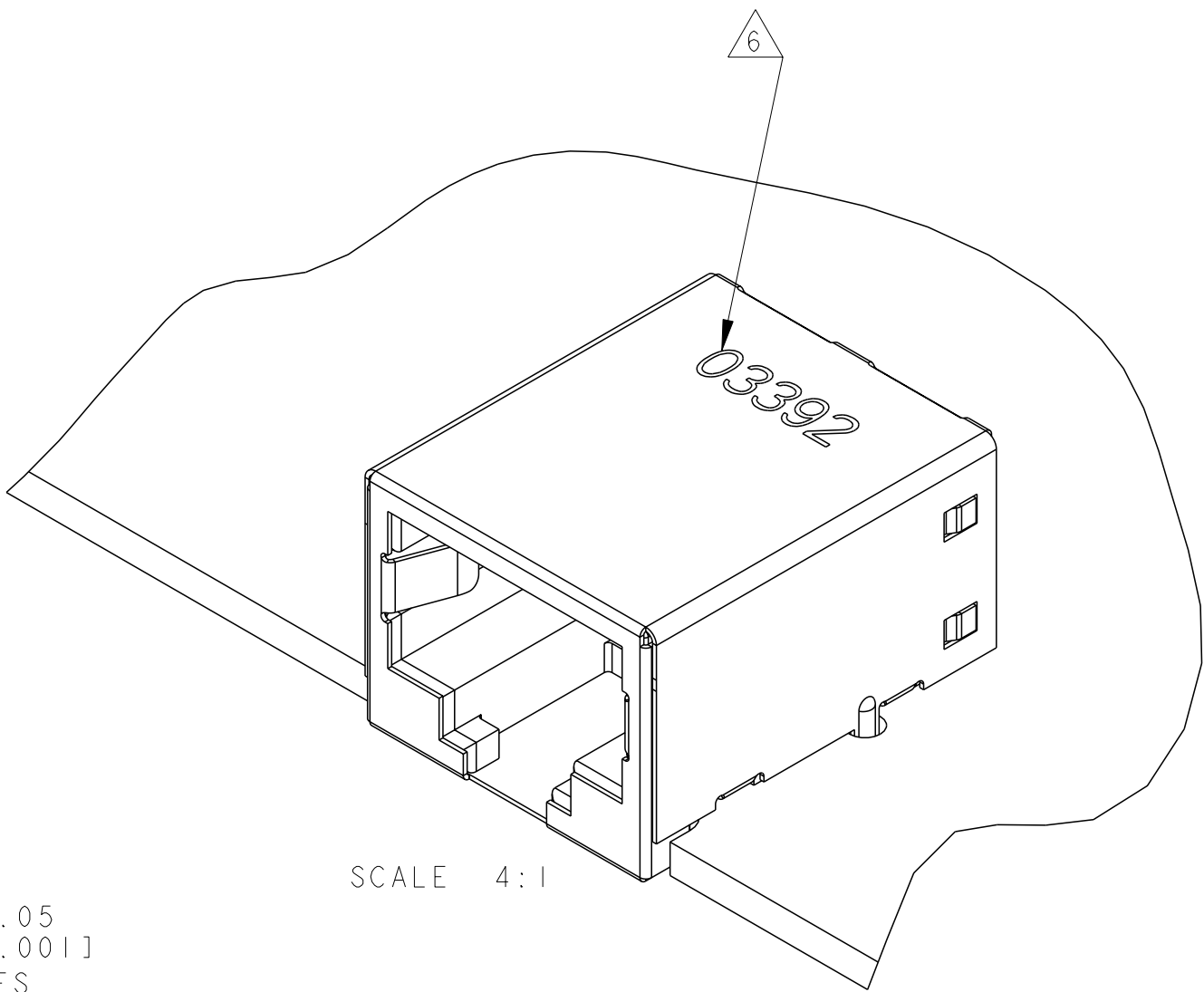


SUGGESTED PANEL CUTOUT
SCALE 4:1

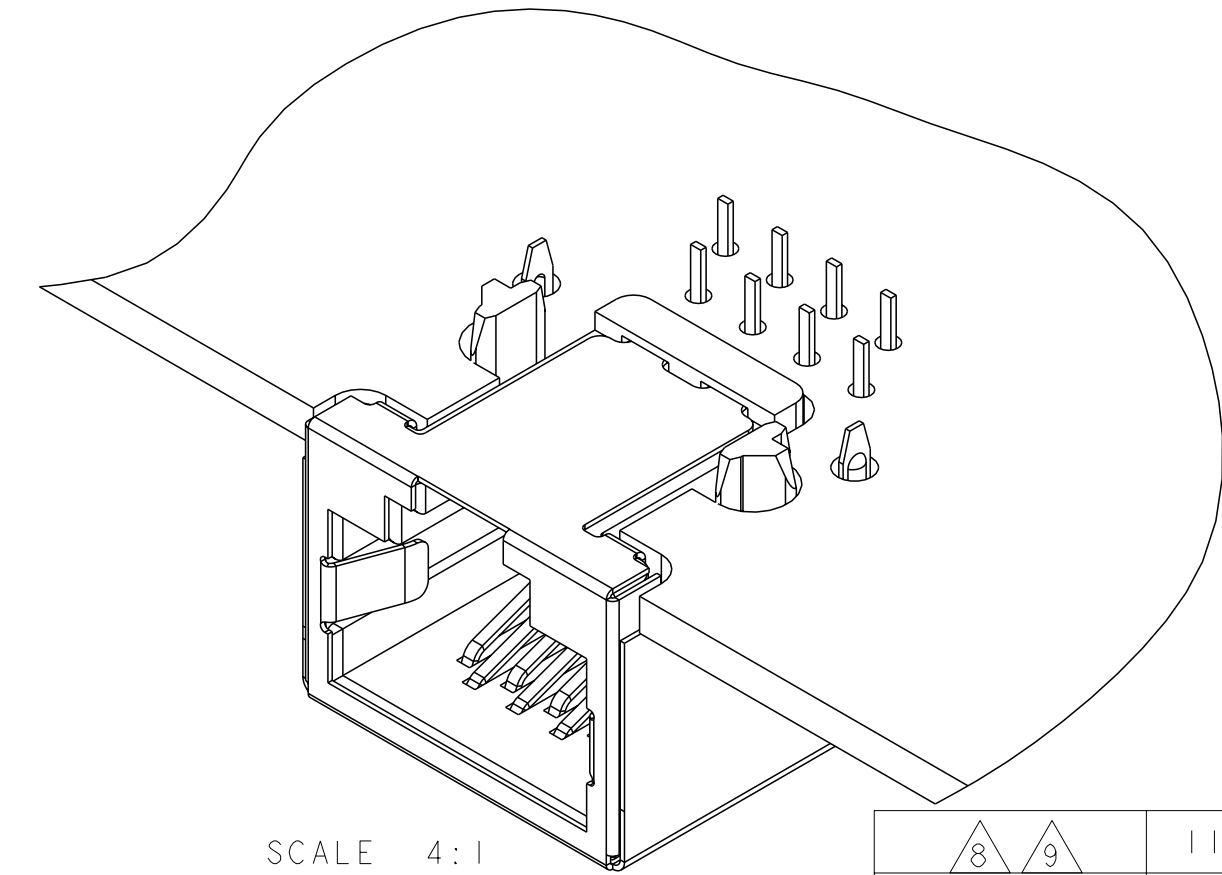


SUGGESTED PRINTED CIRCUIT
BOARD LAYOUT
COMPONENT SIDE
SCALE 6:1

- 1 MATERIAL: HOUSING - HIGH TEMPERATURE NYLON, BLACK, UL 94V-0, TERMINALS - 0.25[.01] THICK PHOSPHOR BRONZE PLATED WITH 3.81um[.000150] MINIMUM THICK BRIGHT TIN-LEAD IN SOLDER AREA, 1.27um[.000050] MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE TERMINAL PLATED WITH 1.27um[.000050] MINIMUM THICK NICKEL. SHIELD - 0.1[.0039] MIN THICK COPPER ZINC ALLOY, PREPLATED WITH 2.0-4.0um (.000079-.000157) THICK TIN OVER 1.27 um (.000050) MIN THICK NICKEL.
- 2 JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.
- 3 THIS DIMENSION REPRESENTS THE TOTAL HEIGHT OF THE CONNECTOR FROM THE TOP OF THE PC BOARD.
- 4 PACKAGED 66 ASSEMBLIES PER PVC TRAY, 396 PER BOX.
- 5 DIELECTRIC WITHSTANDING VOLTAGE BETWEEN SHIELD AND TERMINAL IS 1500 VAC.
- 6 MANUFACTURING DATE CODE:
ORIENTED AND LOCATED APPROXIMATELY AS SHOWN. LASER PRINTING.
TEXT HEIGHT APPROXIMATELY 2MM.
FIRST 2 DIGITS = LAST 2 DIGITS OF YEAR
NEXT 2 DIGITS = MANUFACTURING WORK WEEK
LAST DIGIT = DAY OF WEEK WITH SUNDAY = 1
- 7 MATERIAL: HOUSING - HIGH TEMPERATURE NYLON, BLACK, UL 94V-0, TERMINALS - 0.25[.01] THICK PHOSPHOR BRONZE PLATED WITH 3.81um[.000150] MINIMUM THICK MATTE TIN IN SOLDER AREA, 1.27um[.000050] MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE TERMINAL PLATED WITH 1.27um[.000050] MINIMUM THICK NICKEL. SHIELD - 0.1[.0039] MIN THICK COPPER ZINC ALLOY, PREPLATED WITH 2.0-4.0um (.000079-.000157) THICK TIN OVER 1.27 um (.000050) MIN THICK NICKEL.
- 8 MATERIAL: HOUSING - POLYESTER LCP, NATURE, UL 94V-0, TERMINALS - 0.25[.01] THICK PHOSPHOR BRONZE PLATED WITH 3.81um[.000150] MINIMUM THICK MATTE TIN IN SOLDER AREA, 1.27um[.000050] MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE TERMINAL PLATED WITH 1.27um[.000050] MINIMUM THICK NICKEL. SHIELD - 0.1[.0039] MIN THICK COPPER ZINC ALLOY, PREPLATED WITH 2.0-4.0um (.000079-.000157) THICK TIN OVER 1.27 um (.000050) MIN THICK NICKEL.
- 9 FOR 1116503-3 MATERIAL MARK: >LCP-GF30<.



SCALE 4:1



SCALE 4:1

OBsolete

8	9	1116503-3
7		1116503-2
		1116503-1
MATERIAL/ FINISH		PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN J. AHERON	07APR99	NAME MODULAR JACK ASSEMBLY, 8 POSITION, SHIELDED, 10mm WITHOUT PANEL TABS		RESTRICTED TO -	
DIMENSIONS: mm[INCHES]		CHK D. KEMPKA	07APR99				
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD D. KEMPKA	07APR99	PRODUCT SPEC		SIZE	
0 PLC ±		APPLICATION SPEC		108-1163		CAGE CODE	
1 PLC ±		114-2048		WEIGHT		3.49 grams	
2 PLC ±		MATERIAL		SEE P/N		TABLE	
3 PLC ±		FINISH		SEE P/N		TABLE	
4 PLC ±		CUSTOMER DRAWING		SCALE		1:1	
ANGLES		SHEET		OF		1	
		REV		R			